## 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

#### **General Description**

The MAX41461/MAX41462 is a UHF sub-GHz ISM/SRD transmitter is designed to transmit On-Off Keying (OOK) or Amplitude-Shift Keying (ASK) data in the 286MHz to 960MHz frequency range. It integrates a fractional phaselocked-loop (PLL), so a single, low-cost crystal can be used to generate commonly used world-wide sub-GHz frequencies. The fast response time of the PLL allows for frequency-hopping spread spectrum protocols for increased range and security. The chip also features preset modes with pin-selectable frequencies so that only one wire is required for external microcontroller interface. The only frequency-dependent components required are for the external antenna matching network. Optionally, the device can be put into programmable mode and programmed using an I<sup>2</sup>C interface. The crystal-based the MAX41461/MAX41462 elimiarchitecture of nates many of the common problems with SAWbased transmitters by providing greater modulation depth, faster frequency settling, higher tolerance of the transmit frequency, and reduced temperature dependence. A clock-out signal at 800kHz is also provided.

The MAX41461/MAX41462 provides output power up to +13dBm into a 50 $\Omega$  load while drawing < 8mA (Manchester coded). The output load can be adjusted to increase power up to +16dBm, and a PA boost mode can be enabled at frequencies above 850MHz to compensate for losses. The PA output power can also be controlled using programmable register settings in I<sup>2</sup>C mode.

The MAX41461/MAX41462 also features single-supply operation from +1.8V to +3.6V. The device has an auto-shutdown feature to extend battery life and a fast oscillator wake-up with data activity detection.

The MAX41461/MAX41462 is available in a 10-pin  $\mu$ MAX package and is specified over the -40°C to +105°C extended temperature range. The MAX41461/MAX41462 has an ESD rating of 2.5kV HBM.

#### **Applications**

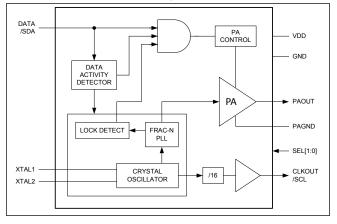
- Building Automation and Security
- Wireless Sensors and Alarms
- Remote and Passive Keyless Entry (RKE/PKE)
- Tire Pressure Monitoring Systems (TPMS)
- Automatic Meter Reading (AMR)
- Garage Door Openers (GDO)
- Radio Control Toys
- Internet of Things (IoT)

## **Benefits and Features**

- Low Implementation Cost
  - Bits-to-RF Single Wire Operation
  - Low Bill-of-Materials (BOM)
  - Uses Single, Low-Cost, 16MHz Crystal
  - Small 3mm x 3mm µMAX-10 Package
- Increased Range, Data Rates, and Security
  - Up to +16dBm PA Output Power
  - Fast Frequency Switching for FHSS/DSSS
  - Fast-On Oscillator: < 250µs Startup Time</li>
  - Up to 200kbps NRZ Data Rate
- Extend Battery Life with Low Supply Current
  - < 8mA ASK Manchester Coded</li>
  - Selectable Standby and Shutdown Modes
  - Auto Shutdown at < 20nA (typ) Current</li>
- Ease of Use
  - Pin Selectable 300MHz-928MHz Frequencies
  - Pin Compatible ASK and FSK Versions
  - +1.8V to +3.6V Single-Supply Operation
  - Fully Programmable with 400kHz/1MHz I<sup>2</sup>C Interface

#### Ordering Information appears at end of data sheet.

#### Simplified Block Diagram





## 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

## **Absolute Maximum Ratings**

V <sub>DD</sub> to GND0.3V to +4V	Junction Temperature+150°C
All Others Pins to GND0.3V to (V <sub>DD</sub> + 0.3)V	Storage Temperature Range60°C to +150°C
Continuous Power Dissipation ( $T_A = +70^{\circ}C$ , derate 5.6mW/°C	Lead Temperature (reflow)+300°C
above +70°C)	Soldering Temperature (reflow)+260°C
Operating Temperature Range40°C to +105°C	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## **Package Information**

#### 10 µMAX (similar to 10 TSSOP)

Package Code	U10+2
Outline Number	<u>21-0061</u>
Land Pattern Number	<u>90-0330</u>
Thermal Resistance, Single-Layer Board:	
Junction-to-Ambient (θ <sub>JA</sub> )	180°C/W
Junction-to-Case Thermal Resistance ( $\theta_{JC}$ )	36°C/W
Thermal Resistance, Four-Layer Board:	
Junction-to-Ambient (θ <sub>JA</sub> )	113.1°C/W
Junction-to-Case Thermal Resistance ( $\theta_{JC}$ )	36°C/W

For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to <u>www.maximintegrated.com/</u> <u>thermal-tutorial</u>.

# 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

## **Electrical Characteristics**

( <u>Typical Application Circuit</u> , all RF inputs and outputs are referenced to $50\Omega$ , V <sub>DD</sub> = +1.8V to +3.6V, T <sub>A</sub> = -40°C to +105°C, P <sub>OUT</sub> =
+13dBm for 300MHz–450MHz or +11dBm for 863MHz–928MHz, PA_BOOST = 0, unless otherwise noted. Typical values are at $V_{DD}$
= +3V, T <sub>A</sub> = +25°C, unless otherwise noted. (Note 1))

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
DC CHARACTERISTICS							
		V <sub>DATA</sub> at 50% duty cycle (ASK) (Note 3, Note 4)	f <sub>RF</sub> = 315MHz		7	12	
			f <sub>RF</sub> = 434MHz		8	12	]
			f <sub>RF</sub> = 863MHz– 928MHz		10	19	_
		V <sub>DATA</sub> at 50% duty	f <sub>RF</sub> = 315MHz, P <sub>OUT</sub> = 16dBm (Note 5)		24		
		cycle (ASK) (Note 3, Note 4)	f <sub>RF</sub> = 434MHz, P <sub>OUT</sub> = 16dBm (Note 5)		26		
Operating Current I <sub>DE</sub>	I <sub>DD</sub>	I <sub>DD</sub>	f <sub>RF</sub> = 863MHz– 928MHz, P <sub>OUT</sub> = 16dBm, PA_BOOST = 1 (Note 5)		45		
		V <sub>DATA</sub> at 50% duty cycle (ASK), Low Phase Noise mode (Note 3, Note 4)	f <sub>RF</sub> = 315MHz		9.5		
			f <sub>RF</sub> = 434MHz		10.5		
			f <sub>RF</sub> = 863MHz–928MHz		12.8		
			f <sub>RF</sub> = 315MHz		2	3	
		PA off (Note 2)	f <sub>RF</sub> = 434MHz		2	3	1
			f <sub>RF</sub> = 863MHz–928MHz		3	4	-
			f <sub>RF</sub> = 315MHz		4		
		PA off, Low Phase Noise mode (Note	f <sub>RF</sub> = 434MHz		4		]
		2)	f <sub>RF</sub> = 863MHz–928MHz		5		-
	N/	PA_BOOST = 0		1.8	3	3.6	v
Supply Voltage	V <sub>DD</sub>	PA_BOOST = 1		1.8	2.7	3.0	v
Standby Current	la	Crystal oscillator	T <sub>A</sub> = 25°C		200	500	
Standby Current	ISTDBY	on, everything off.	T <sub>A</sub> = 105°C		250		μA
Shutdown Current	ISHDN	Everything off	T <sub>A</sub> = 25°C		19	100	nA
MODULATION PARAME	TERS						
ASK Modulation Depth		Supply current and c greatly dependent of PAOUT match			70		dB
Maximum NRZ Data Rate					200		kbps

# 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

## **Electrical Characteristics (continued)**

(<u>Typical Application Circuit</u>, all RF inputs and outputs are referenced to  $50\Omega$ ,  $V_{DD}$  = +1.8V to +3.6V,  $T_A$  = -40°C to +105°C,  $P_{OUT}$  = +13dBm for 300MHz-450MHz or +11dBm for 863MHz-928MHz, PA\_BOOST = 0, unless otherwise noted. Typical values are at  $V_{DD}$  = +3V,  $T_A$  = +25°C, unless otherwise noted. (Note 1))

PARAMETER	SYMBOL	CONDITIONS		MIN	ТҮР	MAX	UNITS
POWER AMPLIFIER							
		f <sub>RF</sub> = 300MHz-450N	/Hz (Note 4)		13		
		f <sub>RF</sub> = 300MHz–450MHz (Note 4, Note 5)			17		1
Output Power P <sub>OUT</sub>	POUT	f <sub>RF</sub> = 863MHz-928N		11		dBm	
		f <sub>RF</sub> = 863MHz–928N PA_BOOST = 1	/Hz (Note 4, Note 5),		16		_
Maximum Carrier Harmonics		PA_BOOST = 0. Sup power, and harmonic board layout and PA	cs are dependent on		-24		dBc
PLL							
		Low Current mode (	default)	286		960	
Francisco Danas		Low Phase Noise me	ode, LODIV = DIV12	286.7		320	
Frequency Range		Low Phase Noise me	ode, LODIV = DIV8	425		480	- MHz
		Low Phase Noise me	ode, LODIV = DIV4	860		960	1
		f <sub>RF</sub> = 315MHz, Low	f <sub>OFFSET</sub> = 200kHz		-82		
		Current mode (default)	f <sub>OFFSET</sub> = 1MHz		-90		dBc/Hz
PLL Phase Noise		f <sub>RF</sub> = 434MHz, Low Current mode (default)	f <sub>OFFSET</sub> = 200kHz		-80		
FLL Flidse Noise			f <sub>OFFSET</sub> = 1MHz		-90		
		f <sub>RF</sub> = 915MHz, Low	f <sub>OFFSET</sub> = 200KHz		-82		
		Phase Noise mode	f <sub>OFFSET</sub> = 1MHz		-104		1
					4		
LO Divider Settings				8			
					12		
Minimum Synthesizer					f <sub>XTAL</sub> /		Hz
Frequency Step					2 <sup>16</sup>		
		f <sub>RF</sub> = 315MHz	f <sub>RF</sub> ± f <sub>XTAL</sub>		-67		
Reference Spur		f <sub>RF</sub> = 434MHz	f <sub>RF</sub> ± f <sub>XTAL</sub>		-60		dBc
		f <sub>RF</sub> = 868MHz	f <sub>RF</sub> ± f <sub>XTAL</sub>		-57		
		f <sub>RF</sub> = 915MHz	f <sub>RF</sub> ± f <sub>XTAL</sub>		-56		
Reference Frequency Input Level					500		mV <sub>P-P</sub>
Frequency Switching Time		26MHz frequency step, 902MHz to 928MHz band, time from end of register write to frequency settled to within 5kHz of desired carrier			50		μs
Loop Bandwidth	LBW			300		kHz	

# 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

## **Electrical Characteristics (continued)**

(<u>Typical Application Circuit</u>, all RF inputs and outputs are referenced to  $50\Omega$ ,  $V_{DD}$  = +1.8V to +3.6V,  $T_A$  = -40°C to +105°C,  $P_{OUT}$  = +13dBm for 300MHz-450MHz or +11dBm for 863MHz-928MHz, PA\_BOOST = 0, unless otherwise noted. Typical values are at  $V_{DD}$  = +3V,  $T_A$  = +25°C, unless otherwise noted. (Note 1))

PARAMETER	SYMBOL	CC	NDITIONS	MIN	TYP	MAX	UNITS
LO Frequency Divider Range	Ν			11		72	
		f <sub>RF</sub> = 315MHz			30		
Turn-On Time of PLL	t <sub>PLL</sub>	f <sub>RF</sub> = 915MHz			90		μs
CRYSTAL OSCILLATOR							
Crystal Frequency	fxtal	Recommended	value (Note 3)	12.8	16	19.2	MHz
Crystal Oscillator Startup Time	t <sub>XO</sub>	See Preset Mode	e Transmission section		243		μs
Frequency Pulling by V <sub>DD</sub>					3		ppm/V
Crystal Input Capacitance	C <sub>X</sub>	Internal capacita XTAL2 pins to gr	nce of XTAL1 and round		12		pF
CMOS INPUT/OUTPUT							
	VIL	SCL/SDA	1.8V compatible			0.36	V
Input Low Voltage	V <sub>IL_SEL</sub>	SEL0/SEL1				0.1 x V <sub>DD3</sub>	
	VIH	SCL/SDA	1.8V compatible	1.44			V
Input High Voltage	V <sub>IH_SEL</sub>	SEL0/SEL1		0.9 x V <sub>DD3</sub>			
Input Current	I <sub>IL</sub> /I <sub>IH</sub>				±10		μA
Output Low Voltage	V <sub>OL</sub>	I <sub>SINK</sub> = 650μA			0.25		V
Output High Voltage	V <sub>OH</sub>	I <sub>SOURCE</sub> = 350µ	A		V <sub>DD</sub> - 0.25		v
Maximum Capacitance at SEL0/SEL1 Pins	C <sub>L_SEL</sub>				10		pF
Maximum Load Capacitance at CLKOUT/SDO Pin	C <sub>LOAD</sub>				10		pF
SERIAL INTERFACE	( <u>FIGURE 1</u> )						
SCL Clock Frequency	f <sub>SCL</sub>			400		1000	kHz
Bus Free Time Between STOP and START Conditions	<sup>t</sup> BUF			500			ns
Hold Time (Repeated) START Condition	<sup>t</sup> HD:STA			260			ns
Low Period of SCL	t <sub>LOW</sub>			500			ns
High Period of SCL	t <sub>HIGH</sub>			260			ns
Data Hold Time		Receive		0		150	
Data Hold Time	<sup>t</sup> HD:DAT	Transmit		0			ns
Data Setup Time	<sup>t</sup> SU:DAT			50			ns

# 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

## **Electrical Characteristics (continued)**

(*Typical Application Circuit*, all RF inputs and outputs are referenced to  $50\Omega$ , V<sub>DD</sub> = +1.8V to +3.6V, T<sub>A</sub> = -40°C to +105°C, P<sub>OUT</sub> = +13dBm for 300MHz–450MHz or +11dBm for 863MHz–928MHz, PA\_BOOST = 0, unless otherwise noted. Typical values are at V<sub>DD</sub> = +3V, T<sub>A</sub> = +25°C, unless otherwise noted. (Note 1))

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
Start Setup Time	t <sub>SU:STA</sub>		260			ns
SDA and SCL Rise Time	t <sub>R</sub>				120	ns
SDA and SCL Fall Time	t <sub>F</sub>		20 x V <sub>IO</sub> /5.5		120	ns
Stop Setup Time	tsu:sto		260			ns
Noise Spike Reject	t <sub>SP</sub>			25		ns

Note 1: Supply current, output power and efficiency are greatly dependent on board layout and PA output match.

**Note 2:** 100% tested at  $T_A = +25^{\circ}$ C. Limits over operating temperature and relevant supply voltage are guaranteed by design and characterization over temperature.

**Note 3:** Guaranteed by design and characterization. Not production tested.

**Note 4:** Typical values are average, peak power is 3dB higher.

**Note 5:** Using high output power match, see <u>Table 3</u>.

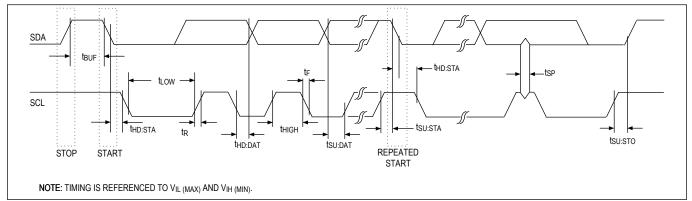
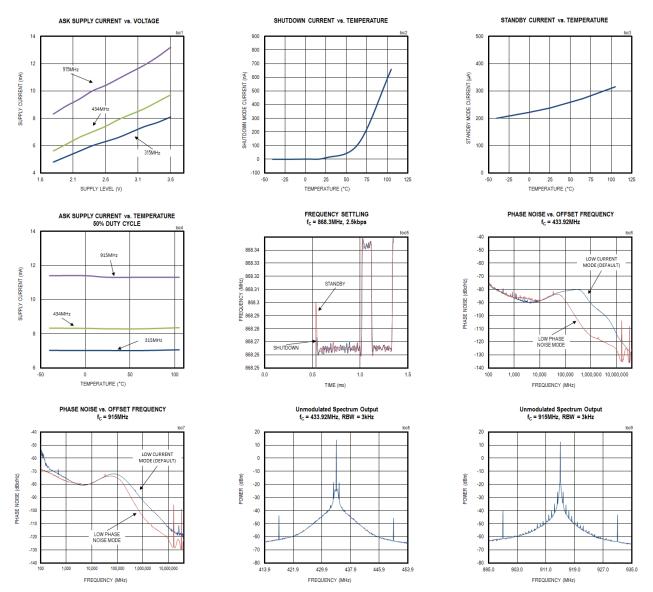


Figure 1. Serial Interface Timing Diagram

# 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

## **Typical Operating Characteristics**

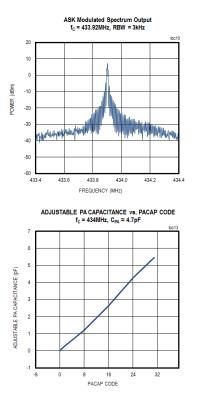
(Typical Application Circuit, RF output terminated to  $50\Omega$ . Typical values are at V<sub>DD</sub> = +3V, T<sub>A</sub> = +25°C, unless otherwise noted.)

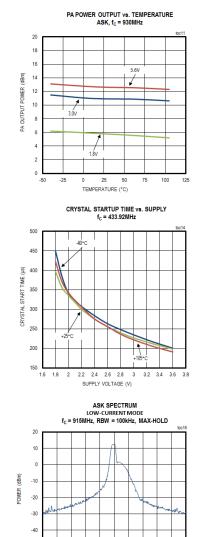


# 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

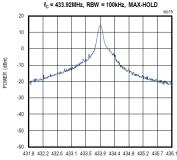
## **Typical Operating Characteristics (continued)**

(Typical Application Circuit, RF output terminated to  $50\Omega$ . Typical values are at V<sub>DD</sub> = +3V, T<sub>A</sub> = +25°C, unless otherwise noted.)





PA OUTPUT POWER vs. PAPWR CODE 15 10 (mgp PA OUTPUT POWER -10 -1 0 2 3 4 1 5 6 8 CODE  $\label{eq:sectrum} \begin{array}{l} \text{ASK SPECTRUM} \\ \text{LOW-CURRENT MODE} \\ \text{f}_{\text{C}} = 433.92 \text{MHz}, \text{ RBW} = 100 \text{kHz}, \text{ MAX-HOLD} \end{array}$ 20 10





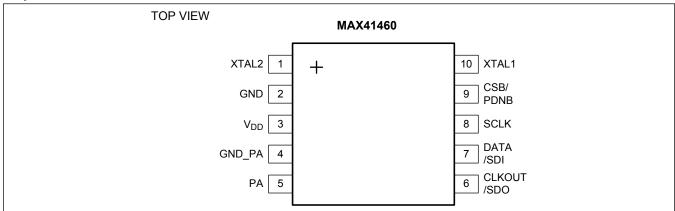
910.4 911.3 912.3 913.2 914.1 915.0 915.9 916.8 917.7 918.7 919.6 FREQUENCY (MHz)

-50 -60

# 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

# **Pin Configurations**

#### 10 µMAX



#### 10 µMAX

TOP VIEW	MAX41461–MAX41464	
		1
XTAL2 1	+	10 XTAL1
GND 2		9 SEL1
V <sub>DD</sub> 3		8 SEL0
GND_PA 4		7 DATA /SDA
PA 5		6 CLKOUT /SCL

# 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

# **Pin Description**

P	IN		
MAX4146 0	MAX4146 1–MAX41 464	NAME	FUNCTION
XTAL2	XTAL2	1	Second Crystal Input. See Crystal Oscillator section.
GND	GND	2	Ground. Connect to system ground.
V <sub>DD</sub>	V <sub>DD</sub>	3	Supply Voltage. Bypass to GND with a 100nF capacitor as close to the pin as possible.
GND_PA	GND_PA	4	Ground for the Power Amplifier (PA). Connect to system ground.
PA	PA	5	Power-Amplifier Output. The PA output requires a pullup inductor to the supply voltage, which can be part of the output-matching network to an antenna.
CLKOUT/ SDO	CLKOUT/ SCL	6	MAX41460: Buffered Clock Output or SPI Data Output. MAX41461–MAX41464: Buffered Clock Output. I <sup>2</sup> C clock input for register programming when in Serial Interface Mode (SEL0 and SEL1 are unconnected or HIZ). The frequency of CLKOUT is 800kHz when not in Program mode.
DATA/SDI	DATA/ SDA	7	MAX41460: Data Input. SPI bus serial data input for register programming when CSB is at logic-low. MAX41461–MAX41464: Data Input. I <sup>2</sup> C serial data input for register programming when in Serial Interface mode (SEL0 and SEL1 are unconnected or HIZ). When not in Program mode, DATA also controls the power-up state (see the <i>Auto-Shutdown in Preset Mode</i> section in the appropriate data sheet).
SCLK	SEL0	8	MAX41460: SPI Bus Serial Clock Input. MAX41461–MAX41464: Three-state Mode Input. See <i>Preset Modes</i> section in the appropriate data sheet for details. For three-state input open, the impedance on the pin must be greater than 1MΩ.
CSB	SEL1	9	MAX41460: SPI Bus Chip Enable. Active Low. MAX41461–MAX41464: Three-state Mode Input. See <i>Preset Modes</i> section in the appropriate data sheet for details. For three-state input open, the impedance on the pin must be greater than 1MΩ.
XTAL1	XTAL1	10	First Crystal Input. See Crystal Oscillator section.

## **Detailed Description**

The MAX41461/MAX41462 is part of the MAX4146x family of UHF sub-GHz ISM/SRD transmitters designed to transmit ASK data in the 286MHz to 960MHz frequency range. The MAX4146x family is available in the following versions.

## Table 1. MAX4146x Versions

VERSION	MODULATION AND INTERFACE	PRESET FREQUENCIES (MHz)
MAX41460	ASK/FSK with SPI	No presets, programmable through SPI
MAX41461	ASK (optional I <sup>2</sup> C)	315/318/319.51/345/433.42/433.92/908/915
MAX41462	ASK (optional I <sup>2</sup> C)	315/433/433.92/434/868/868.3/868.35/868.5
MAX41463	FSK (optional I <sup>2</sup> C)	315/433.42/433.92/908/908.42/908.8/915/916
MAX41464	FSK (optional I <sup>2</sup> C)	315/433.92/868.3/868.35/868.42/868.5/868.95/869.85

The MAX41460 uses an SPI programming interface. The MAX41461–MAX41464 feature an I<sup>2</sup>C interface, as well as preset modes (pin-selectable output frequencies using only one crystal frequency). No programming is required in preset modes and only a single-input data interface to an external microcontroller is needed. The MAX41461/ MAX41462 parts are identical when put in I<sup>2</sup>C programming mode. All MAX4146x versions are fully programmable for all output frequencies, as described in the *Electrical Characteristics* table. The only frequency-dependent components required are for the the external antenna match.

The crystal-based architecture of the MAX41461/MAX41462 provides greater modulation depth, faster frequency settling, higher tolerance of the transmit frequency, and reduced temperature dependence. It integrates a fractional phase-locked-loop (PLL); so a single, low-cost crystal can be used to generate commonly used world-wide sub-GHz frequencies. A buffered clock-out signal make the device compatible with almost any microcontroller or code-hopping generator.

The MAX41461/MAX41462 provides +13dBm output power into a  $50\Omega$  load at 315MHz using an integrated high efficiency power amplifier (PA). The output load can be adjusted to increase power up to +16dBm and a PA boost mode can be enabled at frequencies above 850MHz to compensate for losses. The PA output power can also be controlled using programmable register settings. The MAX41461/MAX41462 feature fast oscillator wake-up upon data activity detection and has an auto-shutdown feature to extend battery life.

The MAX41461/MAX41462 operates at a supply voltage of +1.8V to +3.6V and is available in a 10-pin  $\mu$ MAX package that is specified over the -40°C to +105°C extended temperature range.

#### **Preset Modes**

The MAX41461/MAX41462 contain preset settings depending on the state of pins SEL1 and SEL0. All presets must use a 16MHz crystal. The frequency of the CLKOUT pin is always 800kHz.

## Table 2. Programming and Preset Modes

SEL1 STATE	SEL0 STATE	MAX41461	MAX41462
Ground	Ground	I <sup>2</sup> C Mode	I <sup>2</sup> C Mode
Ground	Open	315	315
Ground	V <sub>DD</sub>	318	433.92
Open	Ground	319.51	433
Open	Open	345	434
Open	V <sub>DD</sub>	908	868.3
V <sub>DD</sub>	Ground	915	868
V <sub>DD</sub>	Open	433.92	868.5
V <sub>DD</sub>	V <sub>DD</sub>	433.42	868.35

#### **Preset Mode Transmission**

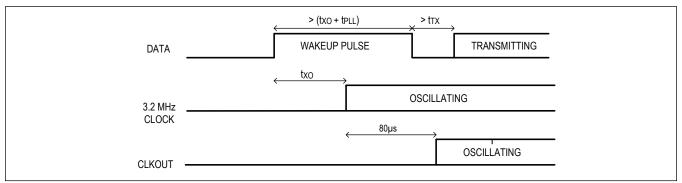
The wake-up of the device is as follows:

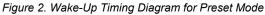
1) The microcontroller sends a wake-up pulse on DATA. The duration of the wake-up pulse should be longer than

txo + tPLL.

2) After the falling edge of wake-up pulse, the microcontroller should wait for at least  $t_{TX}$  time and start data transmission. In preset mode,  $t_{TX} = 10 \mu s$ .

3) CLKOUT is generated 80µs after internal 3.2MHz clock is available.





#### Auto-Shutdown in Preset Mode

The MAX41461/MAX41462 in preset mode has an automatic shutdown feature that places the device in low-power shutdown mode if the DATA input stays at logic 0 for a wait time equal to 2<sup>14</sup> cycles of the internal 3.2MHz clock. This equates to a wait time of approximately 5.1ms.

When the device is in automatic shutdown, a pulse on DATA initiates the warm up of the crystal and PLL. See <u>Startup</u> section for requirements on the wake-up pulse.

When the device is operating, each occurrence of logic 1 on the data line resets an internal counter to zero and it begins to count again. If the counter reaches the end-of-count, the device enters shutdown mode.

#### **Power Amplifier**

The MAX41461/MAX41462 PA is a high-efficiency, open-drain switching-mode amplifier. In a switching-mode amplifier, the gate of the final-stage FET is driven with a 25% duty-cycle square wave at the transmit frequency. The PA also has an internal set of capacitors that can be switched in and out to present different capacitance values at the PA output using the PACAP[4:0] register values. This allows extra flexibility for tuning the output matching network. When the matching network is tuned correctly, the output FET resonates the attached tank circuit (pullup inductor from PA to V<sub>DD</sub>) with a minimum amount of power dissipated in the FET. With a proper output-matching network, the PA can drive a wide range of antenna impedances, which include a PCB trace antenna or a 50 $\Omega$  antenna. The output-matching  $\pi$ -network suppresses the carrier harmonics and transforms the antenna impedance to an optimal impedance at the PA pin. The *Typical Application Circuit* can deliver an output power of +13dBm with a +3.0V supply. Table 3 has approximate PA load impedances for desired output powers.

The PAPWR bits in the PA1 register control the output power of the PA. This setting adjust the number of parallel drivers used, which determine the final output power (see Figure 3).

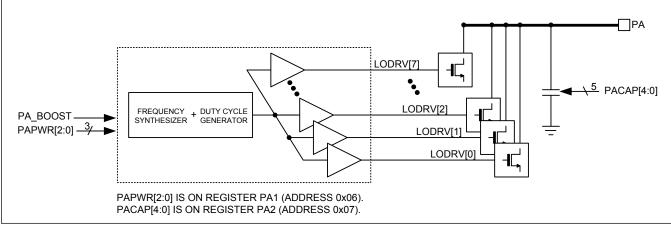


Figure 3. Power Amplifier

#### **Boost Mode**

The PA can deliver up to 16dBm of output power.

High output power can be achieved in two ways:

- Lower the load impedance for the PA by adjusting the output matching network,
- For frequencies over 850MHz, change the duty cycle of the square wave driving the PA from 25% to 50% by setting PA\_BOOST = 1 in register SHDN (0x05) and adjusting the output matching network.

Note that, when using PA\_BOOST = 1, the maximum supply voltage should not exceed 3V. For frequencies under 850MHz, the PA\_BOOST bit should remain at 0, the output match can be adjusted to provide higher output power.

## Table 3. PA Load Impedance for Desired Output Power

FREQUENCY (MHz)	OUTPUT POWER (dBm)	ΡΑ LOAD IMPEDANCE (Ω)
315	13	165
315	16 (PA_BOOST = 0)	45
434	13	180
434	16 (PA_BOOST = 0)	57
863–928	11	190
863–928	16 (PA_BOOST = 1)	34

Refer to the MAX4146x EV Kit User's Guide for details.

#### **Programmable Output Capacitance**

The MAX41461/MAX41462 has an internal set of capacitors that can be switched in and out to present different capacitor values at the PA output. The capacitors are connected from the PA output to ground. This allows changing the tuning network along with the synthesizer divide ratio each time the transmitted frequency changes, making it possible to maintain maximum transmitter power while moving rapidly from one frequency to another.

The variable capacitor is programmed through register PA2 (0x07) bits 4:0 (PACAP). The tuning capacitor has a nominal resolution of 0.18pF, from 0pF to 5.4pF. In preset mode, the variable capacitor is set to 0pF.

#### **Transmitter Power Control**

The transmitter power of the MAX41461/MAX41462 can be set in approximately 2.5dB steps by setting PAPWR[2:0] register bits using the I<sup>2</sup>C interface. The transmitted power (and the transmitter current) can be lowered by increasing the load impedance on the PA. Conversely, the transmitted power can be increased by lowering the load impedance.

#### **Preset Mode Output Power**

The output power of the PA in Preset mode (where both SEL0 and SEL1 pins are not connected to GND) is always set for maximum power level (PAPWR[2:0] = 0x7) for a given load impedance. In order to adjust output power levels in preset mode, the load impedance must be adjusted accordingly.

# 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

#### Crystal (XTAL) Oscillator

The XTAL oscillator in the MAX41461/MAX41462 is designed to present a capacitance of approximately 12pF from the XTAL1 and XTAL2 pins to ground. In most cases, this corresponds to a 6pF load capacitance applied to the external crystal when typical PCB parasitics are included. It is very important to use a crystal with a load capacitance equal to the capacitance of the MAX41461/MAX41462 crystal oscillator plus PCB parasitics. If a crystal designed to oscillate with a different load capacitance is used, the crystal is pulled away from its stated operating frequency introducing an error in the reference frequency. The crystal's natural frequency is typically below its specified frequency. However, when loaded with the specified load capacitance, the crystal is pulled and oscillates at its specified frequency. This pulling is already accounted for in the specification of the load capacitance. Accounting for typical board parasitics, a 16MHz, 12pF crystal is recommended. Please note that adding discrete capacitance on the crystal also increases the startup time and adding too much capacitance could prevent oscillation altogether.

Additional pulling can be calculated if the electrical parameters of the crystal are known. The frequency pulling is given by:

$$f_{P} = \frac{C_{M}}{2} \left( \frac{1}{C_{CASE} + C_{LOAD}} - \frac{1}{C_{CASE} + C_{SPEC}} \right) \times 10^{6}$$

where:

f<sub>P</sub> is the amount the crystal frequency pulled in ppm.

C<sub>M</sub> is the motional capacitance of the crystal.

C<sub>CASE</sub> is the case capacitance.

C<sub>SPFC</sub> is the specified load capacitance.

C<sub>LOAD</sub> is the load capacitance.

When the crystal is loaded as specified (i.e.,  $C_{LOAD} = C_{SPEC}$ ), the frequency pulling equals zero. For additional details on crystal pulling and load capacitance affects, refer to *Maxim Tutorial 5422 – Crystal Calculations for ISM RF Products*.

#### Turn-On Time of Crystal Oscillator

The turn-on time of crystal oscillator (XO), t<sub>XO</sub>, is defined as elapsed time from the instant of turning on XO circuit to the first rising edge of XO divider clock output. The external microcontroller turns on the XO by,

- 1. Sending a wakeup pulse for MAX41461–MAX41464 in the preset mode, or
- 2. Writing to device I<sup>2</sup>C address for MAX41461–MAX41464 in the I<sup>2</sup>C mode, or
- 3. Pulling CSB pin low on the MAX41460.

#### **Crystal Divider**

The recommended crystal frequencies are 13.0MHz, 16.0MHz, and 19.2MHz. An internal clock of 3.2MHz $\pm 0.1$ MHz frequency is required. To maintain the internal 3.2MHz time base, XOCLKDIV[1:0] (register CFG1, 0x00, bit 4) must be programmed, based on the crystal frequency, as shown in <u>Table 4</u>.

## Table 4. Required Crystal Divider Programming

CRYSTAL FREQUENCY (MHz)	Crystal Divider Ratio	XOCLKDIV[1:0]
13.0	4	00
16.0	5	01
19.2	6	10

#### **Crystal Frequency in Preset Mode**

For MAX41461/MAX41462 in preset mode (where *both* SEL0 and SEL1 pins are *not* connected to GND), crystal frequency must be 16MHz to ensure accurate output frequency.

## 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

#### Phase-Locked Loop (PLL)

The MAX41461/MAX41462 utilizes a fully integrated fractional-N PLL for its frequency synthesizer. All PLL components, including loop filter, are included on-chip. The synthesizer has a 16-bit fractional-N topology with a divide ratio that can be set from 11 to 72, allowing the transmit frequency to be adjusted in increments of  $f_{XTAL}/65536$ . The fractional-N architecture also allows exact FSK frequency deviations to be programmed. FSK deviations as low as ±1kHz and as high as ±100kHz can be set by programming the appropriate registers.

The internal VCO can be tuned continuously from 286MHz to 960MHz in normal mode, and from 286MHz–320MHz, 425MHz–480MHz, and 860MHz–960MHz in low phase noise mode.

#### **Frequency Programming**

The desired frequency can be programmed by setting bits FREQ in registers PLL3, PLL4, and PLL5 (0x0B, 0x0C, 0x0D). To calculate the FREQ bits, use:

 $\mathsf{FREQ}[23:0] = \mathsf{ROUND}\left(\frac{65536 \times f_C}{f_{\mathsf{XTAL}}}\right)$ 

See <u>Table 5</u> to program the LODIV bits in register PLL1 (0x08) when choosing a LO frequency. It is recommended to leave bits CPVAL and CPLIN at factory defaults. If integer-N synthesis is desired, set bit FRACMODE = 0 in register PLL1.

## Table 5. LODIV Setting

FREQUENCY RANGE (MHz)	LODIV SETTING
286–960, Low Current Mode	0x0
286–320, Low Phase Noise Mode	0x3
425–480, Low Phase Noise Mode	0x2
860–960, Low Phase Noise Mode	0x1

#### **Fractional-N Spurs**

The 16-bit fractional-N, delta-sigma modulator can produce spurious that can show up on the power amplifier output spectrum. If slight frequency offsets can be tolerated, set the LSB of FREQ (register PLL5, bit 0) to logic-high. Using an odd value (logic 1 at bit 0) of the 24-bit FREQ register will produce lower PLL spurious compared to even values (logic 0 at bit 0).

#### Turn-On Time of PLL

The turn-on time of PLL, t<sub>PLL</sub>, is defined as the elapsed time from the instant when the XO output is available to the instant when PLL frequency acquisition is complete.

## 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

#### Two-Wire I<sup>2</sup>C Serial Interface

When pins SEL0 and SEL1 are grounded, the MAX41461/MAX41462 features a 2-wire I<sup>2</sup>C-compatible serial interface consisting of a serial-data line (SDA) and a serial-clock line (SCL). SDA and SCL facilitate bidirectional communication between the MAX41461/MAX41462 and the master at clock frequencies up to 1MHz. The master device initiates a data transfer on the bus and generates the SCL signal to permit data transfer. The MAX41461/MAX41462 functions as an I<sup>2</sup>C slave device that transfers and receives data to and from the master. Pull SDA and SCL high with external pullup resistors of 1k $\Omega$  or greater, referenced to V<sub>DD</sub> for proper I<sup>2</sup>C operation.

One bit transfers during each SCL clock cycle. A minimum of nine clock cycles is required to transfer a byte into or out of the MAX41461/MAX41462 (8 bits and an ACK/NACK). The data on SDA must remain stable during the high period of the SCL clock pulse. Changes in SDA while SCL is high and stable are considered control signals (see the <u>START and</u> <u>STOP Conditions</u> section). Both SDA and SCL remain high when the bus is not busy.

Figure 4 and Figure 5 show I<sup>2</sup>C Write transaction and I<sup>2</sup>C Read transaction protocols, respectively.

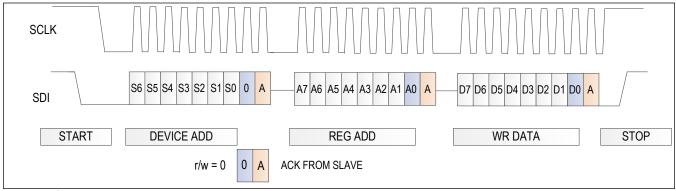


Figure 4. I<sup>2</sup>C Write

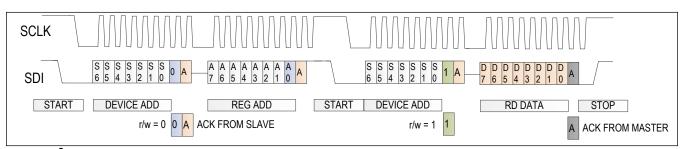


Figure 5. I<sup>2</sup>C Read

#### START and STOP Conditions

The master initiates a transmission with a START condition (S), which is a high-to-low transition on SDA while SCL is high. The master terminates a transmission with a STOP condition (P), which is a low-to-high transition on SDA while SCL is high.

#### Acknowledge and Not-Acknowledge Conditions

Data transfers are framed with an acknowledge bit (ACK) or a not-acknowledge bit (NACK). Both the master and the MAX41461/MAX41462 (slave) generate acknowledge bits. To generate an acknowledge, the receiving device must pull SDA low before the rising edge of the acknowledge-related clock pulse (ninth pulse) and keep it low during the high period of the clock pulse.

To generate a not-acknowledge condition, the receiver allows SDA to be pulled high before the rising edge of the

## 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

acknowledge-related clock pulse, and leaves SDA high during the high period of the clock pulse. Monitoring the acknowledge bits allows for detection of unsuccessful data transfers. An unsuccessful data transfer happens if a receiving device is busy or if a system fault has occurred. In the event of an unsuccessful data transfer, the bus master must reattempt communication at a later time.

#### Slave Address

The MAX41461/MAX41462 has a 7-bit I<sup>2</sup>C slave address that must be sent to the device following a START condition to initiate communication. The slave address is internally programmed to 0xD2 for WRITE and 0xD3 for READ. The MAX41461/MAX41462 continuously awaits a START condition followed by its slave address. When the device recognizes its slave address, it acknowledges by pulling the SDA line low for one clock period, then it is ready to accept or send data, depending on the R/W bit.

#### Write Cycle

When addressed with a write command, the MAX41461/MAX41462 allows the master to write to either a single register or to multiple successive registers.

A write cycle begins with the bus master issuing a START condition, followed by the 7 slave address bits and a write bit (R/W = 0). The MAX41461/MAX41462 issues an ACK if the slave address byte is successfully received. The bus master must then send the address of the first register it wishes to write to (see <u>Register Map</u>). The slave acknowledges the address and the master can then write one byte to the register at the specified address. Data is written beginning with the most significant bit (MSB). The MAX41461/MAX41462 again issues an ACK if the data is successfully written to the register.

The master can continue to write data to the successive internal registers with the MAX41461/MAX41462 acknowledging each successful transfer, or the master can terminate transmission by issuing a STOP condition. The write cycle does not terminate until the master issues a STOP condition.

Figure 6 illustrates I<sup>2</sup>C Burst Write transaction protocol.

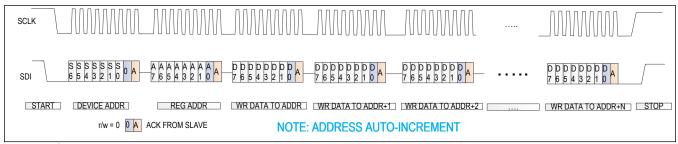


Figure 6. I<sup>2</sup>C Burst Write

#### Read Cycle

When addressed with a read command, the MAX41461/MAX41462 allows the master to read back a single register or multiple successive registers.

A read cycle begins with the bus master issuing a START condition, followed by the 7 slave address bits and a write bit (R/W = 0). The device issues an ACK if the slave address byte is successfully received. The bus master must then send the address of the first register it wishes to read. The slave acknowledges the address. A START condition is then issued by the master, followed by the 7 slave address bits and a read bit (R/W = 1). The device issues an ACK if the slave address byte is successfully received. The device starts sending data MSB first with each SCL clock cycle. At the 9th clock cycle, the master can issue an ACK and continue to read successive registers, or the master can terminate the transmission by issuing a NACK. The read cycle does not terminate until the master issues a STOP condition.

#### **Buffered Clock Output**

MAX41461/MAX41462 provides a buffered clock output (CLKOUT) on pin 6 of the chip in the preset mode, and the frequency of CLKOUT is 800 kHz. In I<sup>2</sup>C mode, MAX41461/MAX41462 uses pin 6 as the SCL line of the I<sup>2</sup>C interface.

CLKOUT\_DELAY[1:0] (register CFG2, address 0x01, bits 7:6) is only used in the preset modes, with a preset value of 0x02. These two register bits are not used in programming mode.

#### State Diagrams

In the I<sup>2</sup>C programming mode, the device has four major states: shutdown, standby, programming, and transmitterenabled. These states describe the power-on or power-off status of the transmitter's three primary internal circuit blocks: the crystal oscillator (XO), the PLL synthesizer, and the power amplifier (PA).

#### Table 6. State Descriptions

State	ХО	PLL	PA
Shutdown	Off	Off	Off
Standby	On	Off	Off
Programming	On	On	Off
Transmitter-Enabled	On	On	On with Ramp-up

Configuration register values are retained in all states unless changed by programming, or if the device is powered off or undergoes a SOFTRESET.

A wake-up byte with 7-bit device address from the I<sup>2</sup>C bus initiates the warm-up of the XO and PLL.

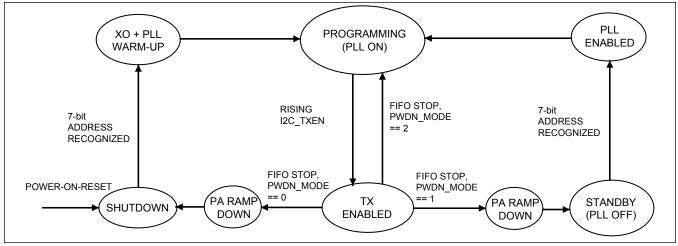
The device can support two types of I<sup>2</sup>C transactions: register access only, and register access followed by data transmission. The event trigger of data transmission is a rising edge on I2C\_TXEN, which is a special signal with two register-bit aliases I2C\_TXEN1 (register CFG6, 0x0A, bit 2) and I2C\_TXEN2 (register CFG7, 0x10, bit 2). A rising edge on I2C\_TXEN can be generated by clearing I2C\_TXEN1 and setting I2C\_TXEN2 in a single I<sup>2</sup>C transaction.

I2C\_TXEN is automatically cleared in two cases: 1) wake-up from shutdown, 2) return to programming state from the transmitter-enabled state. In those two cases, a rising edge on I2C\_TXEN can be generated by setting I2C\_TXEN2 in CFG7, without explicit clearing of I2C\_TXEN1.

Data to be transmitted are written into a special register, byte I2C\_TX\_DATA[7:0] (register I2C3, 0x13, bits 7:0). Automatic incrementing of addresses in I<sup>2</sup>C burst write are disabled for this special register. Each data byte written into I2C\_TX\_DATA will be transferred into a FIFO buffer. The device has an internal 1-bit signal FIFO\_STOP. At the end of data transmission, FIFO\_STOP is set, and the device references the PWDN\_MODE[1:0] (register CFG4, 0x03, bits 1:0) to enter shutdown, standby, or programming state. The shutdown and standby states can only be entered after the transmitter-enabled state.

In both the shutdown and standby states, programming through the I<sup>2</sup>C interface is not allowed. The device will exit the shutdown or standby state once its 7-bit I<sup>2</sup>C address is received.

## 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface





In the preset mode, the MAX41461/MAX41462 device has two major states: shutdown, and transmitter-enabled. After power is applied, the device enters the shutdown state, refer to *Initial Programming*. A rising edge on DATA (pin 7) initiates the warm-up of the XO and PLL. After PLL is locked, a falling edge on DATA enables the transmitter. The device returns to shutdown state when there is no DATA activity, (i.e., DATA stays at 0 for 16384 cycles of the internal 3.2MHz clock).

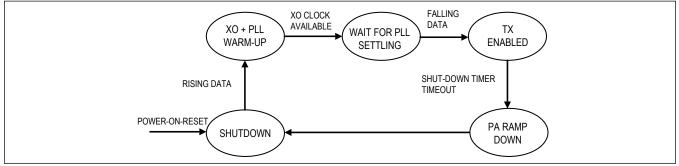


Figure 8. State Diagram in Preset Mode

#### **Initial Programming**

After turning on power supply (or a soft reset), two  $I^2C$  transactions are required to initialize the PLL frequency synthesizer. The first transaction ensures register ADDL2 at address 0x1A is written to its default of 0x80. The second transaction burst-writes 20 consecutive registers from address 0x00 to 0x13.

The device needs to transmit an 8-bit dummy packet for initial programming. The initial programming must clear MODMODE (register CFG1, address 0x00, bit 0), clear I2C\_TXEN1 (register CFG6, address 0x0A, bit 2), configure FREQ[23:0] (register PLL3, PLL4 and PLL5) to desired frequency, set I2C\_TXEN2 (register CFG7, address 0x10, bit 2), and configure I2C\_TX\_DATA[7:0] (register I2C3, address 0x13) to 0x00. In addition, BCLK\_POSTDIV[2:0], BCLK\_PREDIV[7:0], and PKTLEN\_MODE should be configured to default values in the register map.

Initial programming cannot be completed by a single burst-write transaction because the I2C\_TX\_DATA register at address 0x13 is a special register that disables automatic address increment. However, two I<sup>2</sup>C transactions may be merged to a combined transaction, where each write begins with a START mark and the slave address.

After initial programming, the device will enter the shutdown, standby, or programming state according to the setting of PWDN\_MODE[1:0] (register CFG4, address 0x03, bit[1:0]).

#### Startup

#### **Programming Mode**

This section assumes that initial programming is done after power on (or soft reset). Configuration register values are retained in all states unless changed by programming, or if the device is powered off or undergoes a SOFTRESET.

#### Case 1: Using Two I<sup>2</sup>C Transactions for Startup from Shutdown

The startup of MAX41461/MAX41462 in programming mode, from shutdown state, uses two I<sup>2</sup>C transactions: one for configuration update, and the other for data transmission.

In the first I<sup>2</sup>C transaction, the master device burst-writes consecutive registers that are a portion or all of the 16 registers from address 0x00 to 0x0F. Those consecutive registers may or may not include CFG6. If CFG6 is included, the I2C\_TXEN1 bit should be cleared; otherwise, I2C\_TXEN1 is automatically cleared in the wake-up from shutdown.

In the second I<sup>2</sup>C transaction, the master device can set I2C\_TXEN2 (register CFG7, address 0x10, bit 2), configure PKTLEN\_MODE (register I2C1, address 0x11, bit 7) and PKTLEN[14:0], and write the data to be transmitted into I2C\_TX\_DATA (register I2C3, address 0x13). Automatic increment of register address during burst write is disabled at address 0x13.

The event-trigger for wake-up is the recognition of I<sup>2</sup>C address of the MAX41461/MAX41462 device. The event trigger for data transmission is the rising edge I2C\_TXEN that has two aliases of I2C\_TXEN1 and I2C\_TXEN2. The time lag between those two triggers must be longer than  $t_{XO}+t_{PLL}$ . To meet this requirement, the master device can adjust the waiting time between two I<sup>2</sup>C transactions.

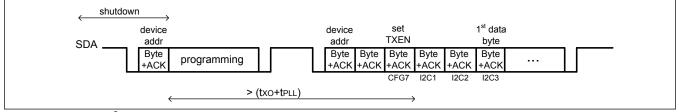


Figure 9. Using Two I<sup>2</sup>C Transactions to Start Data Transmission From the Shutdown State

# Case 2: Using a Single I<sup>2</sup>C Transactions for Startup from Shutdown (recommended for use with I<sup>2</sup>C Fast Mode)

From shutdown state, the start-up of device in programming mode may use a single I<sup>2</sup>C transaction to burst-write consecutive registers starting from address 0x00. Data to be transmitted are written into I2C\_TX\_DATA (register I2C3, address 0x13). Automatic increment of register address during burst write is disabled at address 0x13. The programming should clear I2C\_TXEN1 and set I2C\_TXEN2.

The event-trigger for wake-up is the recognition of I<sup>2</sup>C address of the device. The event-trigger for data transmission is the rising edge of I2C\_TXEN that two aliases of I2C\_TXEN1 and I2C\_TXEN2. The time lag between those two triggers, here 162 cycles of SCL, must be longer than  $t_{XO}$  +  $t_{PLL}$ . To meet this requirement, the fast-mode I<sup>2</sup>C with 400kHz SCL is recommended.

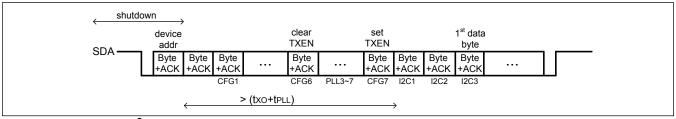


Figure 10. Using a Single I<sup>2</sup>C Transaction to Start Data Transmission From the Shutdown State

# Case 3: Using a Combined I<sup>2</sup>C Transaction for Startup from Shutdown (recommended for use with most I<sup>2</sup>C clock rates)

From shutdown state, the startup of MAX41461/MAX41462 in programming mode can use a combined I<sup>2</sup>C transaction with repeated START marks. In a combined transaction, the master device can do multiple read/write operations without losing control to other master devices on the I<sup>2</sup>C bus. For example, the combined transaction can have a burst-read operation followed by a burst-write operation.

In the burst-write operation, the master device should write consecutive registers starting from CFG7 (address 0x10) or any register preceding CFG7. Data to be transmitted are written into I2C\_TX\_DATA (register I2C3, address 0x13). Automatic incrementing of register addresses during burst-write is disabled at address 0x13. The programming should set I2C\_TXEN2 (and clear I2C\_TXEN1 if CFG6 is included in the registers to write).

The event-trigger for wake-up is the recognition of device address in the burst-read operation. The event-trigger for data transmission is the rising edge of I2C\_TXEN that has two aliases of I2C\_TXEN1 and I2C\_TXEN2. The time lag between those two triggers must be longer than  $t_{XO}$  +  $t_{PLL}$ . To meet this requirement, the master device can adjust the number of registers to read in the burst-read operation.

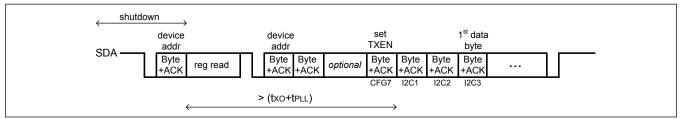


Figure 11. Using a Combined I<sup>2</sup>C Transaction to Start Data Transmission From the Shutdown State

# Case 4: Using a Single I<sup>2</sup>C Transactions for Startup from Standby (recommended for use with I<sup>2</sup>C Fast-mode and I<sup>2</sup>C Fast-mode Plus)

From standby state, the startup of MAX41461/MAX41462 in programming mode can use a single I<sup>2</sup>C transaction to burst-write consecutive registers starting from CFG6 (address 0x0A) or any register preceding CFG6. Data to be transmitted are written into I2C\_TX\_DATA (register I2C3, address 0x13). Automatic incrementing of register addresses during burst-write is disabled at address 0x13. The programming should clear I2C\_TXEN1 and set I2C\_TXEN2.

The event-trigger for wake-up is the recognition of I<sup>2</sup>C address of the device. The event-trigger for data transmission is the rising edge of I2C\_TXEN that two aliases of I2C\_TXEN1 and I2C\_TXEN2. The time lag between those two triggers, here  $\geq$ 72 cycles of SCL, must be longer than t<sub>PLL</sub> for startup from standby. This requirement is met for the fast-mode I<sup>2</sup>C with 400kHz SCL. In the case of Fast-mode Plus I<sup>2</sup>C with 1MHz SCL, the master device can burst-write registers starting from PLL1.

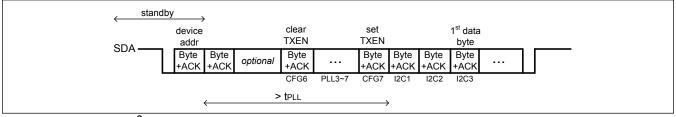


Figure 12. Using a Single  $I^2C$  Transaction to Start Data Transmission From the Standby State

#### Case 5: Using a Single I<sup>2</sup>C Transactions for Startup from Programming

The MAX41461/MAX41462 device can transmit a data packet each time in the transmitter-enabled state. After data transmission, the device refers to the setting of PWDN\_MODE[1:0] to enter the shutdown, standby, or programming state. If the next data packet requires fast start-up, PWDN\_MODE[1:0] can be configured to 0x10 so that the device returns to the programming state.

Then, the master device can use a single I<sup>2</sup>C transaction to burst-write consecutive registers starting from CFG7 (address 0x10) or any register preceding CFG7. Data to be transmitted are written into I2C\_TX\_DATA (register I2C3, address 0x13). Automatic incrementing of register addresses during burst-write is disabled at address 0x13. The programming should set I2C\_TXEN2 (and clear I2C\_TXEN1 if CFG6 is included in the registers to write). There is no restrictions arising from  $t_{XO}$  and  $t_{PLL}$ .

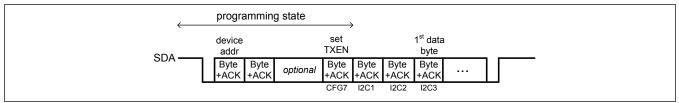


Figure 13. Using a Single I<sup>2</sup>C Transaction to Start Data Transmission From the Programming State

#### **FIFO Buffer**

The I<sup>2</sup>C interface is a bus connected to multiple master or slave devices. The microcontroller is a master device and the MAX41461/MAX41462 is a slave device. The microcontroller can initiate communication with the slave device by I<sup>2</sup>C addressing (e.g., sending a START mark followed by 7-bit device address). The slave device is required to acknowledge every byte transferred through I<sup>2</sup>C.

For data transmission, the microcontroller can burst-write consecutive registers, including CFG7 and I2C3. The purpose of writing CFG7 is to set I2C\_TXEN2 and, therefore, generate a trigger to enable the transmitter. Automatic increment of register address in I<sup>2</sup>C burst-write is disabled for the I2C3 register, which is also named I2C\_TX\_DATA. Once the transmitter is enabled, all bytes written to I2C\_TX\_DATA are moved into a FIFO buffer. The buffer size is 4 bytes. The FIFO buffer is enabled only in the transmitter-enabled state.

A programmable baud-rate clock is used for retrieving and transmitting bits from the FIFO buffer. The baud rate is programmable by BCLK\_PREDIV[7:0] (register CFG3, 0x02, bits 7:0) and BCLK\_POSTDIV[2:0] (register CFG2, 0x01, bits 2:0) as the following expression:

BaudRate =  $\frac{f_{CLK}}{2 \times (1 + BCLK_{PREDIV}) \times 2^{BCLK_{POSTDIV}}}$ 

where f<sub>CLK</sub> is the crystal-divider output clock rate (nominally, 3.2 MHz). Valid values of BCLK\_PREDIV are from 3 to 255. Valid values of BCLK\_POSTDIV are from 1 to 5.

To avoid underflow of the FIFO buffer, the baud-rate must be lower than 8/9 of the SCL clock rate. The device can support three modes of SCL clock frequencies: 100kHz, 400kHz, and 1MHz. In the 100kHz mode, it is recommended to limit baud-rate to no more than 50kbps.

A FIFO overflow is avoided by utilizing the I<sup>2</sup>C clock stretching mechanism. Clock stretching is done before the ACK bit. There is no clock-stretching timeout.

Each time before data transmission, the I2C1 and I2C2 registers are configured to specify PKTLEN\_MODE and PKTLEN[14:0]. Data transmission stops when PKTLEN\_MODE is set and the number of bauds transmitted is equal to PKTLEN[14:0]. Data transmission also stops at FIFO underflow or overflow. An internal 1-bit flag FIFO\_STOP is set at the end of data transmission. The rising edge of FIFO\_STOP serves as the event trigger to disable the transmitter. See <u>State Diagrams</u> section.

When the number of bauds to be transmitted is known before data transmission and less than 32768, it is recommended to set PKTLEN\_MODE and configure PKTLEN[14:0] as the number of bauds to be transmitted. Otherwise, clear PKTLEN\_MODE and utilize FIFO underflow to stop data transmission. Once the microcontroller stops writing I2C\_TX\_DATA, FIFO underflow will occur after the data stored in FIFO buffer are transmitted.

Read-only register I2C4, I2C5, and I2C6 are provided to report diagnostic information for the FIFO buffer.

## 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

#### **Frequency-Hopping**

In programming mode, the frequency synthesizer is initialized to a frequency in a selected ISM band by initial programming. After that, for the purpose of frequency dithering or frequency hopping, the FREQ[23:0] registers can be updated to a new frequency in the same selected band for each data packet to be transmitted.

Because programming is not allowed in the transmitted-enabled state (see <u>State Diagrams</u> section), frequency configuration cannot be changed when PA is enabled. See <u>Startup</u> section for details on how to program the device for data transmission.

After transmitting a data packet, the device enters the shutdown, standby, or programming state according to the setting of PWDN\_MODE[1:0] register. The three options have different startup time for transmitting the the next data packet.

The startup time from shutdown is at least ( $t_{XO} + t_{PLL} + t_{TX}$ ), where  $t_{XO}$  is the turn-on time of crystal oscillator,  $t_{PLL}$  is the turn-on time of PLL,  $t_{TX}$  is the turn-on time of transmitter.

The startup time from standby is at least ( $t_{PLL} + t_{TX}$ ).

The  $t_{TX}$  time is 27 cycles of the SCL clock plus 2 cycles of the baud-rate clock. For example, the SCL clock rate is 1MHz, the baud rate is 100kb/s, the value of  $t_{TX}$  is 47µs. See <u>Electrical Characteristics</u> table for typical values of  $t_{XO}$  and  $t_{PLL}$ .

# 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

# **Register Map**

## **Register Map**

ADDRESS	NAME	MSB							LSB
тх	1	I		l	1	L	1	1	
0x00	CFG1[7:0]	XOCLKDI	ELAY[1:0]	XOCLK	DIV[1:0]	_	FSKSHA PE	<u>SYNC</u>	MODMO DE
0x01	<u>CFG2[7:0]</u>	<u>CLKOUT</u>	<u>DELAY[1:</u> ]	-	-	-	BCL	K_POSTDI\	/ <u>[2:0]</u>
0x02	CFG3[7:0]				BCLK_PR	REDIV[7:0]			
0x03	CFG4[7:0]	-	_	_	_	_	_	PWDN_N	IODE[1:0]
0x04	<u>CFG5[7:0]</u>	-	_			RESER	VED[5:0]		
0x05	<u>SHDN[7:0]</u>	_	-	-	-	-	RESERV ED	RESERV ED	<u>PA_BOO</u> <u>ST</u>
0x06	PA1[7:0]	RE	SERVED[2	:0]	-	-		PAPWR[2:0]	1
0x07	PA2[7:0]	-	-	-			PACAP[4:0]	l	
0x08	PLL1[7:0]	CPLII	<u>v[1:0]</u>	FRACM ODE	RESER	/ED[1:0]	LODI	V[1:0]	LOMOD E
0x09	PLL2[7:0]	RESERV ED	RESERV ED	-	-	-	-	<u>CPVA</u>	.L[1:0]
0x0A	<u>CFG6[7:0]</u>	-	-	-	-	-	<u>I2C_TXE</u> <u>N1</u>	RESERV ED	RESERV ED
0x0B	PLL3[7:0]				FREQ	[23:16]			
0x0C	PLL4[7:0]				FREC	<u>[15:8]</u>			
0x0D	PLL5[7:0]				FREC	<u>[7:0]</u>			
0x0E	PLL6[7:0]	-			<u>[</u>	DELTAF[6:0	1		
0x0F	PLL7[7:0]	-	-	-	-		DELTAF_S	SHAPE[3:0]	
0x10	<u>CFG7[7:0]</u>	_	-	-	-	-	<u>I2C_TXE</u> <u>N2</u>	RESERV ED	RESERV ED
0x11	<u>I2C1[7:0]</u>	PKTLEN _MODE			P	KTLEN[14:	<u>8]</u>		
0x12	<u>l2C2[7:0]</u>				PKTLE	EN[7:0]			
0x13	<u>I2C3[7:0]</u>				<u>12C_TX_</u> [	DATA[7:0]			
0x14	<u>12C4[7:0]</u>	PKTCO MPLETE			TX	_PKTLEN[1	4:8]		
0x15	<u>12C5[7:0]</u>				<u>TX_PKT</u>	LEN[7:0]			
0x16	<u>I2C6[7:0]</u>	UFLOW	<u>OFLOW</u>	EIEO E EIEO EU					
0x17	CFG8[7:0]	_	-	_	_	_	_	_	SOFTRE SET
0x18	<u>CFG9[7:0]</u>		RE	ESERVED[4	:0]		RESERV ED	RESERV ED	RESERV ED
0x19	ADDL1[7:0]	RESER	/ED[1:0]	RESER	VED[1:0]	RESER'	VED[1:0]	RESER	/ED[1:0]
0x1A	ADDL2[7:0]	RESERV ED			RE	ESERVED[6	::0]		

# 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

## **Register Details**

## <u>CFG1 (0x00)</u>

BIT	7	6	5	4		3	2	1	0	
Field	XOCLKDE	LAY[1:0]	XOCLK	DIV[1:0]		_	<u>FSKSHAPE</u>	<u>SYNC</u>	MODMODE	
Reset	0x	2	0:	x1		-	0b0	0b0	0b0	
Access Type	Write,	Read	ead Write, Read				Write, Read	Write, Read	Write, Read	
BITFIELD	BITS		DESCRIPT	ION			D	ECODE		
XOCLKDELA Y	7:6	Start delay t block	pefore enabling	XO clock to di	gital	rest of d 0x1: XO digital bl 0x2: XO digital bl	) clock is enabled after 32 cycles to rest of lock ) clock is enabled after 64 cycles to rest of			
XOCLKDIV	5:4	XO clock div	vision ratio for o	ligital block		0x1: Div time is 2 0x2: Div 0x3: Div	ide XO clock b ide XO clock b cycles, low tin ide XO clock b ide XO clock b cycles, and lo	y 5 for digital c ne is 3 cycles y 6 for digital c y 7 for digital c	lock. High lock lock. High	
FSKSHAPE	2	Sets the sta	Sets the state of FSK Gaussain Shaping				K Shaping disa K Shaping ena			
SYNC	1		Controls if clock output acts as an input. When an input, it will sample the DATA pin.			0x0 0x1				
MODMODE	0	Configures i	Configures modulator mode			0x0: AS 0x1: FS				

### CFG2 (0x01)

BIT	7	6	5	4		3 2 1			0
Field		(OUT_DELAY[1:0]				_	- BCLK_POSTDIV[2:0]		
Reset	0x	(2	-	-		_		0x1	
Access Type	Write, Read		_	_		-	Write, Read		
BITFIELD	BITS		DESCRIPT	ION			D	ECODE	
CLKOUT_DE LAY	7:6		delay when CL on exiting SHUT clock cycles		in	wheneve mode 0x1: CLI wheneve mode 0x2: CLI	KOUT will start er moving into KOUT will start er moving into KOUT will start er moving into	normal mode fr toggling after normal mode fr toggling after 2	om shutdown 128 cycles om shutdown 256 cycles

# 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

BITFIELD	BITS	DESCRIPTION	DECODE
			0x3: CLKOUT will start toggling after 512 cycles whenever moving into normal mode from shutdown mode
BCLK_POST DIV	2:0	Baud clock post-divider setting.	0x0: RESERVED 0x1: Divide by 1 0x2: Divide by 2 0x3: Divide by 3 0x4: Divide by 4 0x5: Divide by 5 0x6: RESERVED 0x7: RESERVED

#### CFG3 (0x02)

BIT	7	6	5	4	3	2	1	0	
Field	BCLK_PREDIV[7:0]								
Reset				0)	(3				
Access Type	Write, Read								
		1							

BITFIELD	BITS	DESCRIPTION	DECODE
BCLK_PRED	7:0	Baud clock predivision ratio. Valid values are from 3 to 255.	0x00: RESERVED 0x01: RESERVED 0x02: RESERVED 0x03: Divide by 3  0xFF: Divide by 255

#### CFG4 (0x03)

BIT	7	6	5	4	3	2	1	0	
Field	-	-	-	-	-	-	PWDN_MODE[1:0]		
Reset	_	-	_	-	-	_	0)	0x0	
Access Type	-	-	-	-	-	-	Write, Read		

BITFIELD	BITS	DESCRIPTION	DECODE
PWDN_MOD E	1:0	Power Down Mode Select	<ul> <li>0x0: SHUTDOWN low power state is enabled.</li> <li>While entering low power state, XO, PLL, and PA are shutdown.</li> <li>0x1: STANDBY low power state is enabled. While entering low power state, XO is enabled. PLL and PA are shutdown</li> <li>0x2: FAST WAKEUP low power state is enabled.</li> <li>While entering low power state, XO and PLL are enabled. PA is shutdown.</li> <li>0x3: Will revert to 0x2</li> </ul>

# 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

#### CFG5 (0x04)

BIT	7	6	5	4	3	2	1	0
Field	-	_	RESERVED[5:0]					
Reset	-	-			0x	:00		
Access Type	_	-			Write	, Read		
BITFIE	LD	BITS	DESCRIPTION					
RESERVED		5:0	Write to 00 hex.					

#### SHDN (0x05)

BIT	7	6	5	4		3	2	1	0
Field	_	_	_	_		_	RESERVED	RESERVED	PA_BOOST
Reset	_	_	_	_		_	0x1	0x0	0x0
Access Type	-	-	-	_		-	Write, Read	Write, Read	Write, Read
BITFIELD	BITS	DESCRIPTION				DECODE			
RESERVED	2	Write to 1 bi	nary.			1			
RESERVED	1	Write to 0 bi	nary.			0			
PA_BOOST	0	frequencies	oost in PA outp above 850MH match compar	z. This require	sa		Output power	in normal operation in boost mode	

#### PA1 (0x06)

BIT	7	6	5	4	3	2	1	0	
Field	<u>F</u>	RESERVED[2:0	0]	-	_		PAPWR[2:0]		
Reset		0x4		-	_				
Access Type		Write, Read		-	_		Write, Read		
BITFIELD	BITS		DESCRIPT	ION		DECODE			
RESERVED	7:5	Write to 100 binary.			100				
PAPWR	2:0	Controls the parallel drive		ver by enabling	0x1: 2   0x2: 3	Drivers Drivers Drivers Drivers Drivers	r		

# 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

BIT	7	6	5	4	3	2	1	0
Field	-	_	_			PACAP[4:0]		
Reset	_	_	_			0x0		
Access Type	-	-	-			Write, Read		
BITFIELD	BITS		DESCRIPT	TION DECODE				
PACAP	4:0	Controls shu fF.	unt capacitanc	e on PA output	0x00: 0 0x01: 17 0x02: 35 0x03: 52 0x04: 70 0x05: 87 0x06: 10 0x07: 12 0x08: 14 0x09: 15 0x0A: 17 0x08: 14 0x09: 15 0x0A: 17 0x0B: 19 0x0C: 22 0x0E: 22 0x10: 28 0x10: 28 0x11: 29 0x12: 31 0x13: 33 0x14: 35 0x15: 36 0x16: 38 0x17: 42 0x18: 42 0x18: 42 0x10: 45 0x1C: 45 0x1C: 45 0x1E: 52 0x1F: 52	50 25 50 25 50 25 250 250		

#### PA2 (0x07)

#### PLL1 (0x08)

BIT	7	6	5	4		3	2	1	0
Field	CPLI	N[1:0]	FRACMOD E	RESER	/ED[1	<u>[0:]</u>	LODI	V[1:0]	LOMODE
Reset	0)	<b>k</b> 1	0x1	0x	00		0x0		0b0
Access Type	Write,	Read	Write, Read	Write,	Read	ł			Write, Read
BITFIELD	BITS		DESCRIPT	ION			D	ECODE	
CPLIN	7:6	for fractiona	el of charge pu l N mode to im e. Set to 'DISAI	prove close in		DECODE 0x0: No extra current 0x1: 5% of charge pump current 0x2: 10% of charge pump current			

# 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

BITFIELD	BITS	DESCRIPTION	DECODE
		mode.	0x3: 15% of charge pump current
FRACMODE	5	Sets PLL between fractional-N and integer-N mode.	0x0: Integer N Mode 0x1: Fractional N Mode
RESERVED	4:3	Write to 00 binary.	00
LODIV	2:1		0x0: Disabled 0x1: LC VCO divided by 4 0x2: LC VCO divided by 8 0x3: LC VCO divided by 12
LOMODE	0	Sets LO generation. For lower power, choose LOWCURRENT. For higher performance, choose LOWNOISE.	0x0: Ring Oscillator Mode 0x1: LC VCO Mode

## <u>PLL2 (0x09)</u>

BIT	7	6	5	4	3	2	1	0	
Field	<u>RESERVED</u>	<u>RESERVED</u>	-	-	-	-	<u>CPVA</u>	L[1:0]	
Reset	0x0	0b0	_	-	-	-	0	k0	
Access Type	Write, Read	Write, Read	-	_	_	_	Write,	Read	
BITFIELD	BITS		DESCRIPT	ION		DECODE			
RESERVED	7	Write to 0 bi	nary.		0				
RESERVED	6	Write to 0 bi	nary.		0				
CPVAL	1:0	Sets Charge	Pump Curren	t	0x0: 5µ 0x1: 10 0x2: 15 0x3: 20	μA μA			

### <u>CFG6 (0x0A)</u>

BIT	7	6	5	4	3	2	1	0	
Field	-	-	-	-	-	I2C_TXEN1	<u>RESERVED</u>	<u>RESERVED</u>	
Reset	-	_	-	-	-	0x0	0x0	0x0	
Access Type	-	_	-	-	-	Write, Read	Write, Read	Write, Read	
BITFIELD	BITS		DECODIDE			DECODE			
	DIIS		DESCRIPT	ION		D	ECODE		
I2C_TXEN1	2			n in I <sup>2</sup> C mode.		ta transmission ta transmission	not enabled in		
I2C_TXEN1 RESERVED			TA transmissio	n in I <sup>2</sup> C mode.		ta transmission	not enabled in		

# 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

#### PLL3 (0x0B)

BIT	7	6	5	4	3	2	1	0		
Field			-	FREQ[23:16]						
Reset		0x13								
Access Type				Write,	Read					
BITFIE	LD	BITS		DESCRIPTION						
FREQ 7:0			FREQ value to PLL. LO frequency= FREQ<23:0>/2^16*fXTAL							

#### <u>PLL4 (0x0C)</u>

BIT	7	6	5	4	3	2	1	0	
Field		FREQ[15:8]							
Reset		0xB0							
Access Type		Write, Read							
BITFIEL	D	BITS		DESCRIPTION					
FREQ		7:0	FREG	FREQ value to PLL					

#### PLL5 (0x0D)

BIT	7	6	5	4	3	2	1	0	
Field		<u>FREQ[7:0]</u>							
Reset		0x00							
Access Type		Write, Read							
BITFIEL	D	BITS		DESCRIPTION					
FREQ		7:0	FREG	FREQ value to PLL					

#### PLL6 (0x0E)

BIT	7	6	5	4	3	2	1	0	
Field	-				DELTAF[6:0]				
Reset	_		0x28						
Access Type	_			Write, Read					
BITFIEI	D	BITS			DES	SCRIPTION			
DELTAF		6:0	devia	For FSK mode, MODMODE=1 and FSKSHAPE=0, sets the frequency deviation from the space frequency for the mark frequency. fDELTA = DELTAF[6:0] * fXTAL/ 8192					

# 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

#### PLL7 (0x0F)

BIT	7	6	5	5	4	3	2	1	0
Field	-	-	-	-	-	DELTAF_SHAPE[3:0]			
Reset	-	-	-	-	-	0x4			
Access Type	-	_	-	-	-	Write, Read			
BITFIE	LD	BITS				DESCRIPTION			
DELTAF_SHA	PE.	3:0		devia	tion from the s	DMODE = 1 and FSKSHAPE = 1, sets the frequency bace frequency for the mark frequency. fDELTA = 0] * fXTAL / 81920			

#### CFG7 (0x10)

BIT	7	6	5	4		3	2	1	0
Field	-	-	-	-		-	I2C_TXEN2	RESERVED	<u>RESERVED</u>
Reset	-	-	-	-		-	0x0	0x0	0x0
Access Type	_	-	-	-		-	Write, Read	Write, Read	Write, Read
BITFIELD	BITS		DESCRIPT	ION			D	ECODE	
I2C_TXEN2	2		ATA transmis sed address	ssion in I <sup>2</sup> C for I2C_TXE	N1	0x0: Data transmission not enabled in I <sup>2</sup> C m 0x1: Data transmission enabled in I <sup>2</sup> C mode			
RESERVED	1				•				
RESERVED	0	Write to 0 bi	narv						

#### <u>I2C1 (0x11)</u>

BIT	7	6	5	4	3	2	1	0		
Field	PKTLEN_M ODE				PKTLEN[14:8]					
Reset	0x0		0x0							
Access Type	Write, Read		Write, Read							
BITFIELD	BITS		DESCRIPT	ION		[	DECODE			
					program as end o	0x0: PKTLEN[14:0] need not be programmed. FIFO underflow event will be treate as end of packet event. For cases where actual packet length is greater than 32767 bits, it is				

PKTLEN_MO DE	7	Packet Length Mode	packet length is greater than 32767 bits, it is expected that the $\mu$ C will pad such a packet to make it an integral multiple of 8-bits 0x1: PKTLEN[14:0] will provide the length of packet. Once FIFO is read for PKTLEN[14:0] bits, or if FIFO underflow, MAX4146x will consider that as an end of packet event.
PKTLEN	6:0	Packet Length	

# 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

#### <u>I2C2 (0x12)</u>

BIT	7	6	5	4	3	2	1	0			
Field		· ·	•	<u>PKTLEN[7:0]</u>							
Reset		0xFF									
Access Type				Write,	Read						
BITFIE	LD	BITS		DESCRIPTION							
PKTLEN		7:0	Pack	Packet Length							

#### <u>I2C3 (0x13)</u>

BIT	7	6	5	4	3	2	1	0		
Field				<u>12C_TX_</u> [	DATA[7:0]					
Reset		0x0								
Access Type		Write, Read								
BITFIE	LD	BITS			DE	SCRIPTION				
I2C_TX_DATA	x	7:0	addre	smit data to be ess, I <sup>2</sup> C registe , and subseque	r address will n	ot auto increm	nent within an l <sup>2</sup>			

#### <u>l2C4 (0x14)</u>

BIT	7	6	5	4		3	2	1	0	
Field	PKTCOMPL ETE		TX_PKTLEN[14:8]							
Reset	0x0		0x0							
Access Type	Read Only		Read Only							
BITFIELD	BITS		DESCRIPT	ION			D	ECODE		
PKTCOMPL ETE	7	Indicates if F	Packet tranmiss	sion is complet		0x0: Packet transmission is not completed 0x1: Packet transmission is completed				
TX_PKTLEN	6:0	Provides status information of bits transmitted for the current packet								

#### <u>l2C5 (0x15)</u>

BIT	7	6	5	5 4 3 2 1							
Field			TX_PKTLEN[7:0]								
Reset		0x0									
Access Type				Read	Only						
BITFIEI	LD	BITS		DESCRIPTION							
TX_PKTLEN	X_PKTLEN 7:0		Provi	Provides status information of bits transmitted for the current packet							

# 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

#### <u>I2C6 (0x16)</u>

BIT	7	6	5	5	4	3	2	2 1 0		
Field	UFLOW	OFLOW	FIFO T		FIFO_FULL	-	FIFO_WORDS[2:0]		<u>:0]</u>	
Reset	0x0	0x0	0×	:1	0x0	_		0x0		
Access Type	Read On	ly Read Only	Read	Only	Read Only	-	Read Only			
BITFIE	LD	BITS				DE	SCRIPTION			
UFLOW		7		FIFO	Underflow state	us				
OFLOW		6		FIFO	Overflow status	S				
FIFO_EMPTY		5		FIFO	Empty Status					
FIFO_FULL		4		FIFO	Full Status					
FIFO_WORDS	6	2:0			field captures th on corresponds		f locations currently filled in FIFO. Each a word			

## <u>CFG8 (0x17)</u>

BIT	7	6	5	4	3	2	1	0
Field	_	-	-	-	-	-	-	SOFTRESE T
Reset	_	-	-	-	_	_	-	0b0
Access Type	_	_	-	-	-	-	-	Write, Read
BITFIELD	BITS		DESCRIPT	ION		D	ECODE	
SOFTRESET	0	Places DUT	into software r	eset.	0x0: Deassert the reset 0x1: Resets the entire digital, until this bit is so 0			

#### <u>CFG9 (0x18)</u>

BIT	7	6 5 4			3	2	1	0
Field		Ē	RESERVED[4:(	<u>[]</u>		RESERVED	<u>RESERVED</u>	<u>RESERVED</u>
Reset			0x0			0x0	0x0	0x0
Access Type			Write, Read			Write, Read	Write, Read	Write, Read
BITFIELD	BITS		DESCRIPT	ION		D	ECODE	
RESERVED	7:3	Write to 0_0	000 binary.		00000			
RESERVED	2	Write to 0 bi	nary.		0			
RESERVED	1	Write to 0 bi	nary.		0			
RESERVED	0	Write to 0 bi	nary.		0			

# 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

#### ADDL1 (0x19)

BIT	7	6	5 4		3	2	1	0	
Field	RESER\	/ED[1:0]	RESER	VED[1:0]	RESER	VED[1:0]	RESERVED[1:0]		
Reset	0x	:0	0:	x0	0:	x0	0>	<b>(</b> 0	
Access Type	Write,	Read	Write, Read Write, Read Write		Write, Read Write, Read		Read		
BITFIELD	BITS		DESCRIPT	ION		D	ECODE		
RESERVED	7:6	Write to 00 b	pinary.		00	00			
RESERVED	5:4	Write to 00 b	pinary.		00	00			
RESERVED	3:2	Write to 00 b	/rite to 00 binary.			00			
RESERVED	1:0	Write to 00 b	/rite to 00 binary.			00			

#### ADDL2 (0x1A)

BIT	7	6	5	4	3	2	1	0		
Field	<u>RESERVED</u>		RESERVED[6:0]							
Reset	0x1		0x0							
Access Type	Write, Read		Write, Read							
BITFIELD	BITS		DESCRIPT	ION		C	ECODE			
RESERVED	7	Write to 1 bi	Vrite to 1 binary. 1							
RESERVED	6:0	Write to 000	Write to 000_0000 binary.         0000000							

## **Applications Information**

#### Power-On Programming

#### Preset Mode

To ensure the MAX41461/MAX41462 device enters shutdown state after power-on, the DATA pin must be held low at power-on. If the DATA pin cannot be guaranteed low at power-on, then a high-value pulldown resistor is recommended. After  $V_{DD}$  has settled, a logic-low-high-low transition on DATA must occur in the preset mode. If the pulse duration of low-high-low transition is longer than  $t_{XO}$  +  $t_{PLL}$ , it is a valid wake-up pulse before data transmission. It is also allowed to have a short pulse duration between 5µs and 20µs. The short pulse will not wake up the device.

#### Programming Mode

After turning on power supply in I<sup>2</sup>C mode, a logic-high-low-high transition on SDA must occur to minimize leakage current in shutdown state. It is highly recommended that the I<sup>2</sup>C resistors are connected to the MAX41461/MAX41462  $V_{DD}$ .

Two I<sup>2</sup>C transactions are required to initialize the PLL frequency synthesizer. The first transaction ensures register ADDL2 at address 0x1A is written to its default of 0x80. The second transaction burst-writes 20 consecutive registers from address 0x00 to 0x13. The device is programmed to transmit a dummy packet with 8 zero bits in ASK mode. There is no RF emission at PA output. See *Initial Programming* section.

For example, the crystal frequency is 16MHz, the RF frequency is 315MHz, the 20 consecutive registers from address 0x00 to 0x13 can be configured as:

[0x90, 0x81, 0x03, 0x00, 0x00, 0x04, 0x80, 0x80, 0x60, 0x00, 0x00, 0xC4, 0xDE, 0x98, 0x28, 0x04, 0x04, 0x00, 0xFF, 0x00]

After initial programming, the device will enter the shutdown, standby, or programming state according to the setting of PWDN\_MODE[1:0] (register CFG4, address 0x03, bit[1:0]). Configuration register values are retained in all states unless changed by programming, or if the device is powered off or undergoes a SOFTRESET. See <u>Startup</u> section for directions to program the device for data transmission.

#### **ASK Carrier Frequency**

The ASK carrier frequency is set by the FREQ bits in registers 0x0B, 0x0C, and 0x0D. The user calculates the divide ratio based on the carrier frequency and crystal frequency. The following equation shows how to determine the correct value to be loaded into the FREQ registers.

$$FREQ = \left(\frac{fRF}{fXTAL}\right) \times 65536$$

For example, the desired ASK transmit frequency is 315MHz and the crystal frequency is 16MHz. 315/16 is 19.6875.  $19.6875 \times 65536$  is 1290240. Converted into hex, the value is 0x13B000. This value is loaded into FREQ[23:0]. In the case where the value is non-integer, the value may be rounded to the nearest integer.

#### **Tuning Capacitor Settings**

The internal variable shunt capacitor, which can be used to match the PA to the antenna with changing transmitter frequency, is controlled by setting the 5-bit cap variable in the registers. This allows for 32 levels of shunt capacitance control. Since the control of these 5 bits is independent of the other settings, any capacitance value can be chosen at any frequency, making it possible to maintain maximum transmitter efficiency while moving rapidly from one frequency to another. The internal tuning capacitor adds 0 to 5.425pF to the PA output in 0.175pF steps.

## 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

#### **Crystal Frequency Selection**

In order to avoid integer boundary spurs in fractional-N PLL synthesizers, the crystal should be selected so that the RF carrier frequency is more than 0.4MHz apart from the nearest integer multiple of crystal frequency.

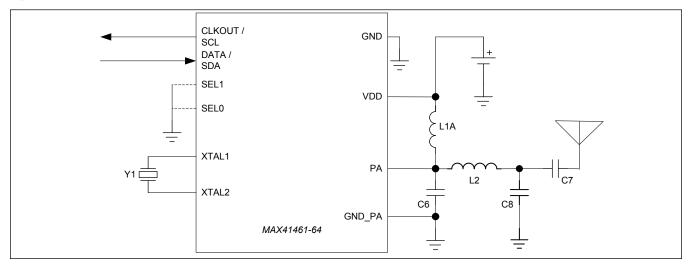
For example, the 16±0.002MHz crystals can be selected for the 433.92MHz RF carrier, which is more than 0.4MHz apart from the nearest integer multiple of crystal frequency at 432±0.054MHz. However, the 16±0.002MHz crystals are not suitable for a RF carrier at 912MHz or 928MHz.

In the programming mode, the crystal divider ratio is programmable. The crystal divider ratio should be configured so that the divided clock frequency is 3.2±0.1MHz. In addition, the PLL synthesizer requires a reference frequency (same as crystal frequency) between 12.8MHz and 19.2MHz. Therefore, when crystal divider ratio is 4, 5, or 6, allowed range of crystal frequency is 12.8MHz~13.2MHz, 15.5MHz~16.5MHz, or 18.6MHz~19.2MHz.

In another example, desired RF frequencies are 319.5MHz, 345.0MHz, and 433.92MHz, and recommended crystal selection is 13±0.002MHz so that integer boundary spurs are completely suppressed for three desired RF frequencies. Nevertheless, the 16±0.002MHz and 19.2±0.002MHz crystals are also acceptable.

In the preset mode, the crystal divider ratio is preset at 5. When the RF carrier frequency is very close to an integer multiple of 16MHz, the crystal selection can change to 16.384MHz or 16.128MHz, and the RF carrier frequency should be preset through OTP memory in production.

## **Typical Application Circuit**



#### **Ordering Information**

PART NUMBER	TEMPERATURE RANGE	PIN-PACKAGE
MAX41461GUB+	-40°C to +105°C	10 µMAX
MAX41461GUB+T	-40°C to +105°C	10 µMAX
MAX41462GUB+	-40°C to +105°C	10 µMAX
MAX41462GUB+T	-40°C to +105°C	10 µMAX

+Denotes a lead(Pb)-free/RoHS-compliant package.

T = Tape-and-reel.

## 300MHz–960MHz ASK Transmitter with I<sup>2</sup>C Interface

## **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	10/18	Initial release	—
1	3/19	Updated TSSOP references to µMAX	1, 2, 9, 11, 38

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Телефон: +7 812 627 14 35

Электронная почта: sales@st-electron.ru

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